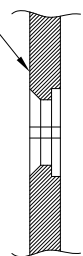


建議密封方式

IP67

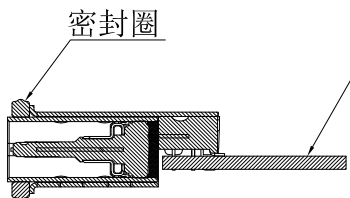


機殼面板

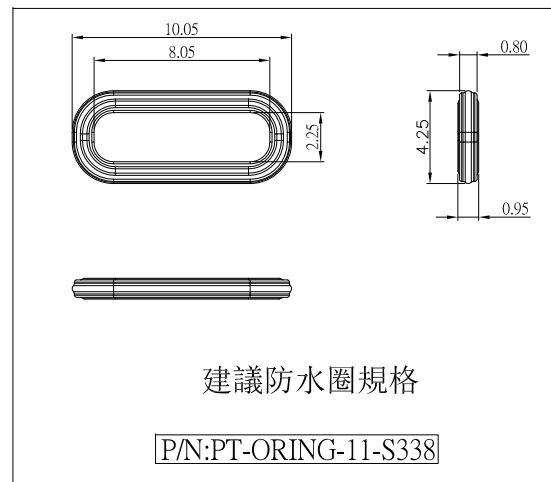


密封圈

PCB板



前後組裝方式



建議防水圈規格

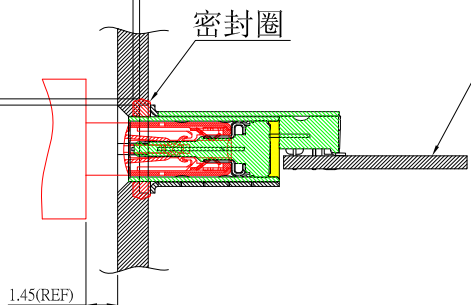
P/N:PT-ORING-11-S338

機殼面板對密封圈與縮量0.30Min
(建議壓縮量為密封圈直徑大小40~50%)

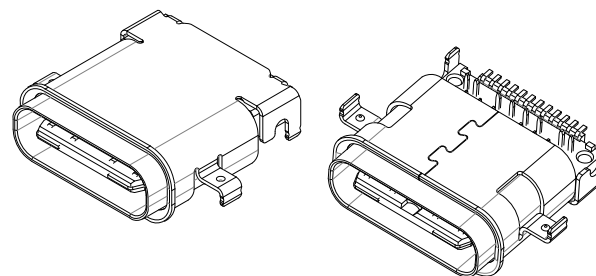
機殼面板對密封圈與縮量0.30Min
(建議壓縮量為密封圈直徑大小40~50%)

密封圈

PCB板



組裝面板後公母頭對插示意圖



ITEM NO.	DESCRIPTION	DRAWN	DATE
4	新增防水膠圈料號	Jack	060321
3	更新防水等級	Jack	062519
2	更新為A0版	Jack	110117
1	更新防水等級	Jack	090717



建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED:

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD. ANGEL'S



UNITS MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	06/03/21		MODLE	USB 3.1 TYPE C 沉板式防水型 IP67
CHECKED BY:	DATE	FINISH	DWG NO.	SBC-WP240M1-31x-S338
Jacky Chen	06/03/21		SCALE	1 : 1
APPROVED BY:	DATE	SHEET NO.	PART NO.	SBC-WP240M1-31x-S338
Tony Kao	06/03/21	2 of 2		

SIZE A4
VER R4